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(12) United States Patent

Chistyakov

(54) HIGH-POWER PULSED MAGNETRON SPUTTERING

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This patent is subject to a terminal dis-

claimer.

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See application file for complete search history.

(56) References Cited

U.S. PATENT DOCUMENTS

3,516,920	A	6/1970	Muly, Jr. et al.
4,953,174	A	8/1990	Eldridge et al 372/87
4,965,248	A	10/1990	Poppe et al 505/1
5,015,493	A	5/1991	Gruen 427/38
5,616,224	A	4/1997	Boling
5,875,207	A	2/1999	Osmanow 372/86
5,942,089	A	8/1999	Sproul et al.
6,083,361	A	7/2000	Kobayashi et al.
6,296,742	В1	10/2001	Kouznetsov 204/192.12
6.342.132	B1	1/2002	Rossnagel

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6,440,280 B1 8/2002 Burton et al. 6,456,642 B1 9/2002 Hilliard 2002/0033480 A1 3/2002 Kawamata et al. 2005/0252763 A1* 11/2005 Chistyakov		204/298.	Hilliard Kawamata et al.	8/2002 8/2002 9/2002 3/2002	B1 B1 B1 A1	6,456,642 2002/0033480
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FOREIGN PATENT DOCUMENTS

DE 3210351 A1 9/1983

(Continued)

OTHER PUBLICATIONS

Booth, et al., The Transition From Symmetric To Asymmetric Discharges In Pulsed 13.56 MHz Capacity Coupled Plasmas, J. Appl. Phys., Jul. 15, 1997, pp. 552-560, vol. 82 (2), American Institute of Physics.

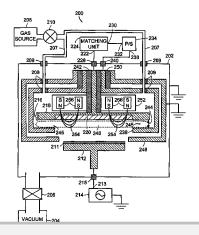
(Continued)

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(57) ABSTRACT

Magnetically enhanced sputtering methods and apparatus are described. A magnetically enhanced sputtering source according to the present invention includes an anode and a cathode assembly having a target that is positioned adjacent to the anode. An ionization source generates a weaklyionized plasma proximate to the anode and the cathode assembly. A magnet is positioned to generate a magnetic field proximate to the weakly-ionized plasma. The magnetic field substantially traps electrons in the weakly-ionized plasma proximate to the sputtering target. A power supply produces an electric field in a gap between the anode and the cathode assembly. The electric field generates excited atoms in the weakly ionized plasma and generates secondary electrons from the sputtering target. The secondary electrons ionize the excited atoms, thereby creating a strongly-ionized plasma having ions that impact a surface of the sputtering target to generate sputtering flux.

50 Claims, 18 Drawing Sheets





FOREIGN PATENT DOCUMENTS

EP	0 788 139 A1		8/1997
GB	1339910		12/1973
JР	57194254		11/1982
JР	10204633		8/1998
WO	WO9504368	*	2/1995
WO	WO 98/40532		9/1998
WO	WO 01/98553 A1		12/2001

OTHER PUBLICATIONS

Bunshah, et al., Deposition Technologies For Films And Coatings, Materials Science Series, pp. 176-183, Noyes Publications, Park Ridge, New Jersey.

Daugherty, et al., Attachment-Dominated Electron-Beam-Ionized Discharges, Applied Science Letters, May 15, 1976, vol. 28, No. 10, American Institute of Physics.

Goto, et al., Dual Excitation Reactive Ion Etcher for Low Energy Plasma Processing, J. Vac. Sci. Technol. A, Sep./Oct. 1992, pp. 3048-3054, vol. 10, No. 5, American Vacuum Society.

Kouznetsov, et al., A Novel Pulsed Magnetron Sputter Technique Utilizing Very High Target Power Densities, Surface & Coatings Technology, pp. 290-293, Elsevier Sciences S.A.

Lindquist, et al., High Selectivity Plasma Etching Of Silicon Dioxide With A Dual Frequency 27/2 MHz Capacitive RF Discharge. Macak, Reactive Sputter Deposition Process of Al203 and Characterization Of A Novel High Plasma Density Pulsed Magnetron Discharge, Linkoping Studies in Science And Technology, 1999, pp. 1-2. Sweden.

Macak, et al., Ionized Sputter Deposition Using An Extremely High Plasma Density Pulsed Magnetron Discharge, J. Vac. Sci. Technol. A., Jul./Aug. 2000, pp. 1533-1537, vol. 18, No. 4, American Vacuum Society.

Mozgrin, et al., High-Current Low-Pressure Quasi -Stationary Discharge In A Magnetic Field: Experimental Research, Plasma Physics Reports, 1995, pp. 400-409, vol. 21, No. 5, Mozgrin, Feitsov, Khodachenko

Rossnagel, et al., Induced Drift Currents In Circular Planar Magnetrons, J. Vac. Sci. Technol. A., Jan./Feb. 1987, pp. 88-91, vol. 5, No. 1, American Vacuum Society.

Sheridan, et al., Electron Velocity Distribution Functions In A Sputtering Magnetron Discharge For The EXB Direction, J. Vac. Sci. Technol. A., Jul./Aug. 1998, pp. 2173-2176, vol. 16, No. 4, American Vacuum Society.

Steinbruchel, A Simple Formula For Low-Energy Sputtering Yields, Applied Physics A., 1985, pp. 37-42, vol. 36, Springer-Verlag.

Turenko, et al., Magnetron Discharge In The Vapor Of The Cathode Material, Soviet Technical Physics Letters, Jul. 1989, pp. 519-520; vol. 15, No. 7, New York, US.

Encyclopedia Of Low Temperature Plasma, p. 119, vol. 3.

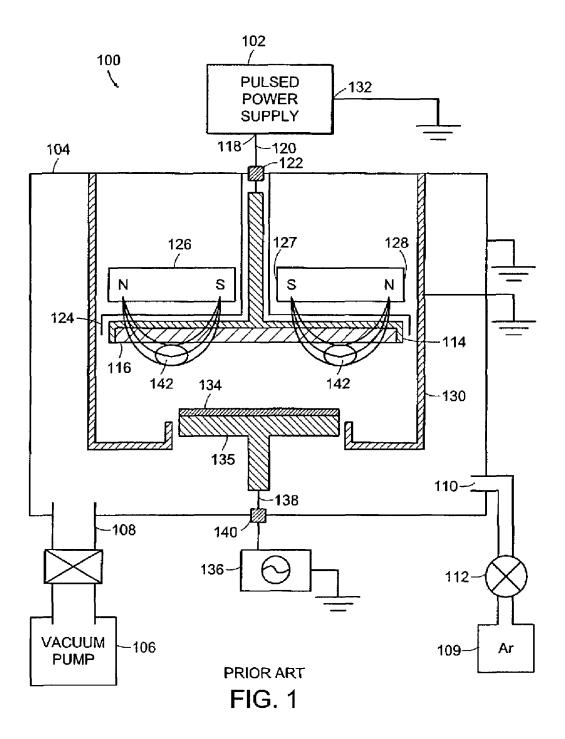
Encyclopedia Of Low Temperature Plasma, p. 123, vol. 3.

Sugimoto, et al; Magnetic Condensation Of A Photoexcited Plasma During Fluoropolymer Sputtering; J. Appl. Phys.; Feb. 15, 1990; pp. 2093-2099; vol. 67, No. 4; American Institute of Physics; New York, US.

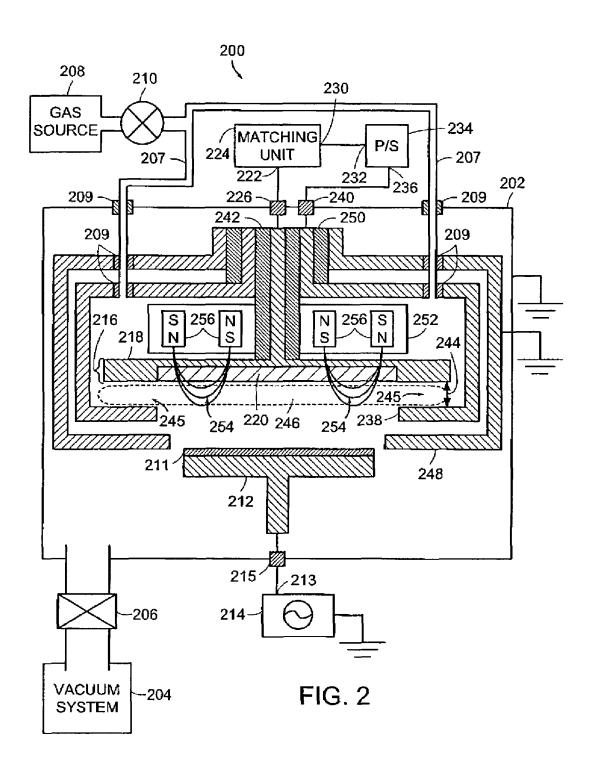
Yamaya, et al; Use Of A Helicon-Wave Excited Plasma For Aluminum-Doped ZnO Thin-Film Sputtering; Appl. Phys. Lett.; Jan. 12, 1998; pp. 235-237; vol. 72; No. 2; American Institute of Physics: New York US.

* cited by examiner

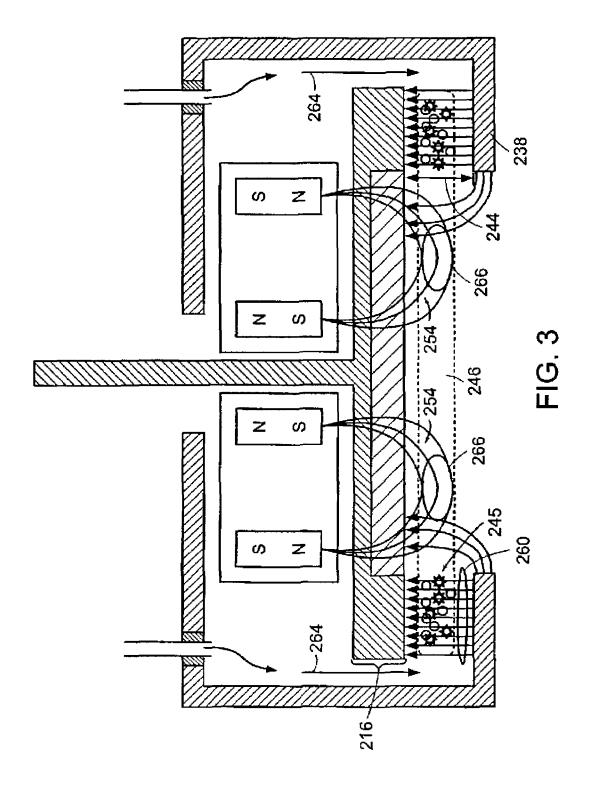














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